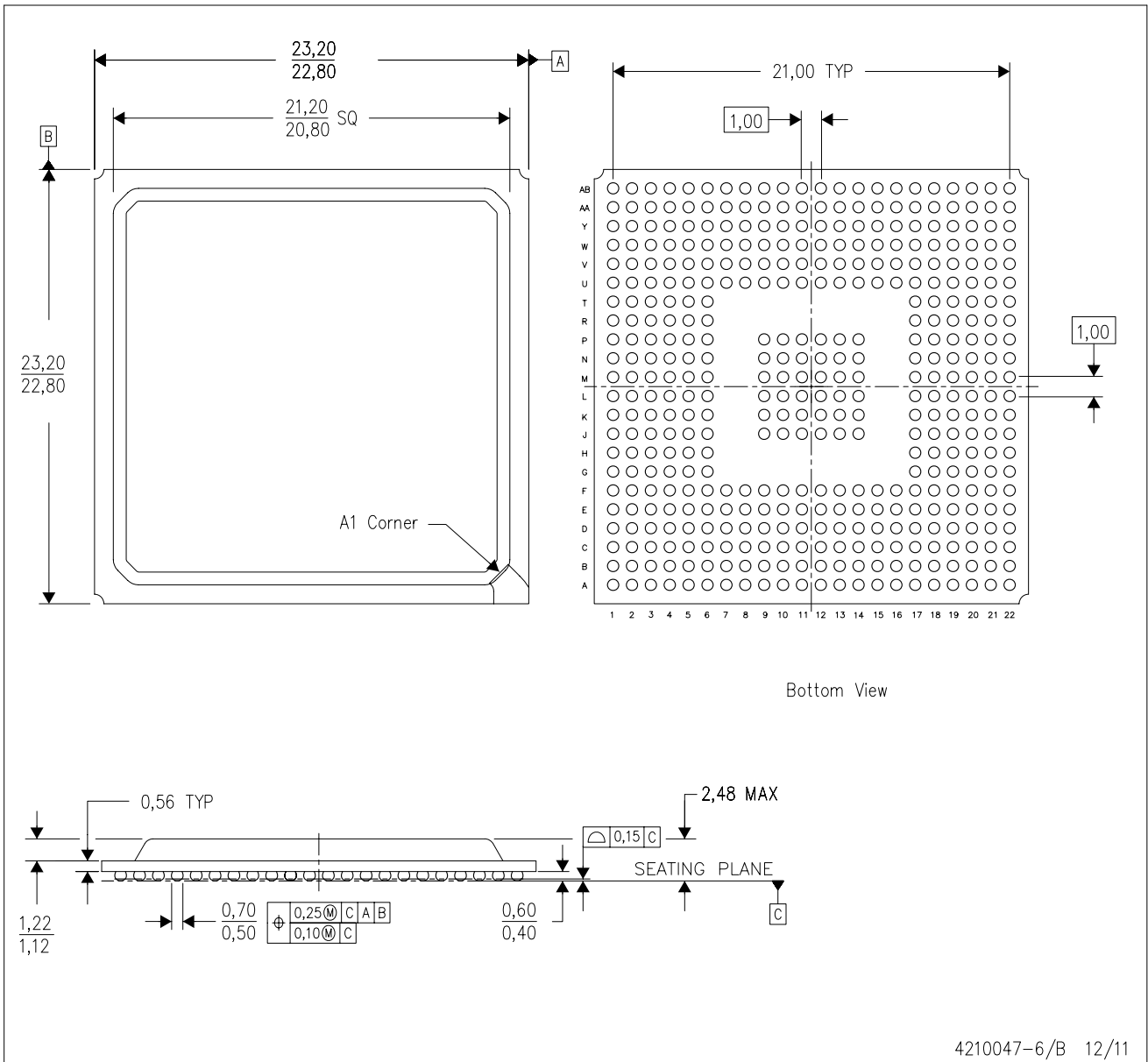


ZDB (S-PBGA-N420)

PLASTIC BALL GRID ARRAY



4210047-6/B 12/11

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Falls within JEDEC MO-151
 - Thermally enhanced plastic package
 - This package is a Pb free solder ball design.

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